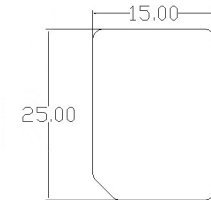


RECOMMENDED PCB PATTERN DIM.

TOLERANCE : ±0.05

- A.Material:
 1.Insulator:High temperature thermoplastic UL94V-0,(BLACK LCP)
 2.Pho.Bronze:Plating,
 50U" MIN NICKEL UNDERPLATED;
 3-8U" GOLD ON THE CONTACT AREA;
 100U" TIN PLATING ON SOLDER TAIL
- B.Electrical specifications:
 Voltage rating: 10 V AC
 Current rating: 0.5A
 Dielectric strength: 500V AC for 1 minute min
 Insulation resistance: 1000 M ohm
 Contact resistance: 100 mill.ohm max
 Operation temperature: -25° to +95°
 Product withstanding rff low soldering 260° for 10s
- C.Mechanical specieications:
 3.1 Durability: 5000 cycles

XKSIM-011B-P8-X



2FF SIM CARD

②	Terminal	6	COPPER ALLOY	
①	Housing	1	LCP UL 94V-0	BLACK
ITEM	PAPT NAMF	QTY	MATERIAL	FINISHING

					ANGLAR	±5°	DSND		DATE		SCALE: N/A	MODEL TYPE: SIM CARD CONN		
					L ≤ 4	±0.2	DWN		DATE		VIEW:	PART NO.:		
					4 < L ≤ 16	±0.3	CHKD		DATE		UNIT: mm	DWG NO.: XKSIM-011B-P8-X		
					16 < L ≤ 63	±0.4	APPD		DATE		SIZE: A4			
					L > 63	±0.5	Kosod Technology Co., Ltd.					WEIGHT	SHEET	REVISION
					UNSPECIFIED TOLERANCES							1.0g	1/1	A0
MARK	DESCRIPTION	REVISIONS	DATE	REVISED	APPROVED									
	www.bodongkaiguan.net	www.ksdkg.com												